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Editorial

This Special Issue contains selected papers presented at the Fifth International Symposium on Electrochemical Impedance Spectroscopy, held in Marilleva, Trento, Italy in June 2001.

About 160 papers were presented (half of which oral and half poster) during the 5 days of the conference.

The participants were from 36 different countries, representing the whole world. We are proud of the warm atmosphere felt in Marilleva and of the friendship continuing in the difficult time we are living at present.

The number and the quality of works presented in Marilleva prove once again that EIS is an essential technique in electrochemistry and a rapidly developing experimental method for many technical fields such as corrosion protection, fuel cells, surface characterisation, solid electrolytes, and others more.

Continuing the tradition of the four previous successful Symposia held in Bombannes 89, Santa Barbara 92, Ysermonde 95 and Agra dos Reis 98, both papers dealing with theoretical aspects and with applications of EIS were presented. Scientific discussion was always very open and thorough after the oral presentation and during the successful poster discussion sessions, chaired

by M. Orazem, M. Musiani, J. Vogelsang and B. Tribollet.

We hope that this volume, collecting many interesting papers presented in Marilleva, will be an useful tool for scientists working with Electrochemical Impedance Spectroscopy.

We would like to take this opportunity to express our gratitude to the local organising committee and in particular to Consuelo Beber and Giovanna Carlà for the assistance before, during and after the Conference. We also gratefully acknowledge the contributions to the success of the Symposium of the Advisory Board, Chairpersons, Authors, Reviewers and Attendees.

We hope to meet again with all the participants, together with many new friends, in 2004 in Florida for the next edition of the Symposium organised by Mark E. Orazem, to whom we express our best wishes.

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